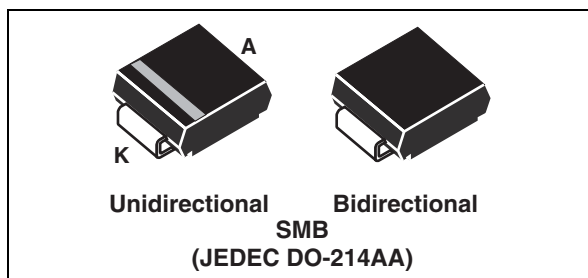


Automotive 600 W Transil™

Datasheet - production data



Features

- Peak pulse power:
 - 600 W (10/1000 μ s)
 - 4 kW (8/20 μ s)
- Stand-off voltage range: from 6 V to 70 V
- Unidirectional and bidirectional types
- Low leakage current:
 - 0.2 μ A at 25 °C
 - 1 μ A at 85 °C
- Operating $T_{j \max}$: 150 °C
- High power capability at $T_{j \max}$:
 - 515 W (10/1000 μ s)
- JEDEC registered package outline
- Resin meets UL 94, V0
- AEC-Q101 qualified

Complies with the following standards

- ISO 10605, C = 150 pF, R = 330 Ω :
 - 30 kV (air discharge)
 - 30 kV (contact discharge)
- ISO 10605, C = 330 pF, R = 330 Ω :
 - 30 kV (air discharge)
 - 30 kV (contact discharge)

- ISO 7637-2^(a)
 - Pulse 1: $V_S = -150$ V
 - Pulse 2a: $V_S = +112$ V
 - Pulse 3a: $V_S = -220$ V
 - Pulse 3b: $V_S = +150$ V

Description

The SM6TY Transil series has been designed to protect sensitive automotive circuits against surges defined in ISO 7637-2 and against electrostatic discharges according to ISO 10605.

The planar technology makes this device compatible with high-end circuits where low leakage current and high junction temperature are required to provide reliability and stability over time. SM6TY are packaged in SMB (SMB footprint in accordance with IPC 7531 standard).

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a. Not applicable to parts with stand-off voltage lower than the average battery voltage (13.5 V)

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

| Symbol | Parameter | | Value | Unit |
|-------------------|---|--|------------|--------------------|
| V_{PP} | Peak pulse voltage | ISO 10605 (C = 330 pF, R = 330 Ω): | | |
| | | Contact discharge | 30 | kV |
| | | Air discharge | 30 | |
| | | ISO 10605 (C = 150 pF, R = 330 Ω): | | |
| Contact discharge | 30 | | | |
| | Air discharge | 30 | | |
| P_{PP} | Peak pulse power dissipation ⁽¹⁾ | T_j initial = T_{amb} | 600 | W |
| T_j | Operating junction temperature range | | -55 to 150 | $^{\circ}\text{C}$ |
| T_{stg} | Storage temperature range | | -65 to 150 | $^{\circ}\text{C}$ |
| T_L | Maximum lead temperature for soldering during 10 s. | | 260 | $^{\circ}\text{C}$ |

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Figure 1. Electrical characteristics - definitions

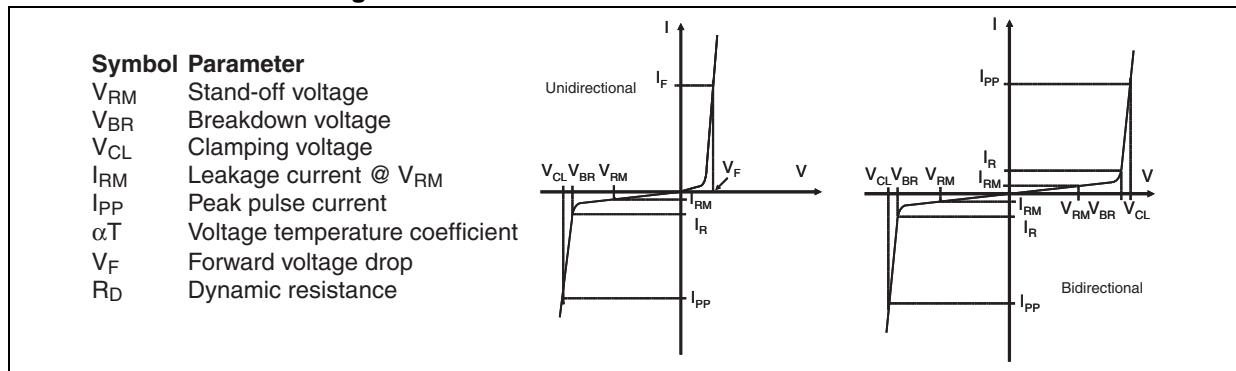


Figure 2. Pulse definition for electrical characteristics

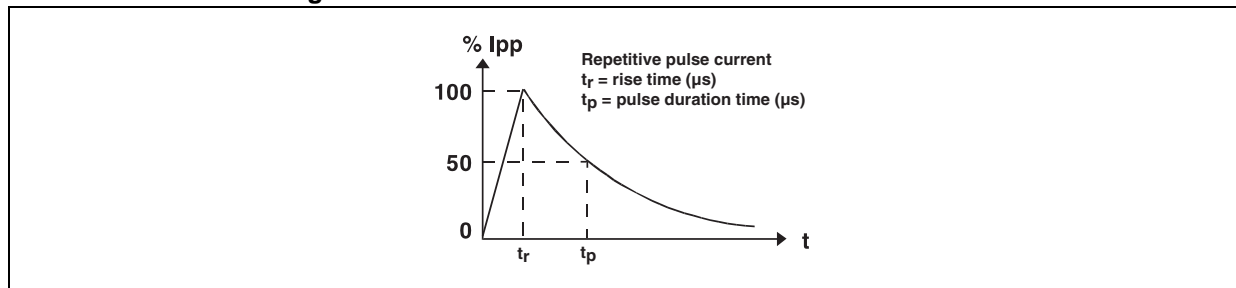


Table 2. Electrical characteristics, parameter values ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

| Order code | I_{RM} max at V_{RM} | | V_{BR} at I_R (1) | | | | V_{CL} at I_{PP} 10/1000 μs | | R_D (2) 10/1000 μs | V_{CL} at I_{PP} 8/20 μs | | R_D (2) 8/20 μs | αT | |
|----------------|--------------------------|----|-----------------------|------|------|------|--|------|---------------------------------|---|------|------------------------------|--------------------------|------|
| | 25 | 85 | min. | typ. | max. | | max. | | | max. | | | max. | |
| | $^{\circ}\text{C}$ | | | | | | | | | | | | | V |
| | μA | V | V | | | mA | V(3) | A(4) | Ω | V(3) | A(4) | Ω | 10-4/ $^{\circ}\text{C}$ | |
| SM6T6V8AY/CAY | 20 | 50 | 5.80 | 6.45 | 6.80 | 7.10 | 10 | 10.5 | 57.0 | 0.059 | 13.4 | 298 | 0.021 | 5.70 |
| SM6T7V5AY/CAY | 20 | 50 | 6.40 | 7.13 | 7.50 | 7.90 | 10 | 11.3 | 53.0 | 0.065 | 14.5 | 276 | 0.024 | 6.10 |
| SM6T10AY/CAY | 20 | 50 | 8.55 | 9.50 | 10.0 | 10.5 | 1 | 14.5 | 41.0 | 0.098 | 18.6 | 215 | 0.038 | 7.30 |
| SM6T12AY/CAY | 0.2 | 1 | 10.2 | 11.4 | 12.0 | 12.6 | 1 | 16.7 | 36.0 | 0.114 | 21.7 | 184 | 0.049 | 7.80 |
| SM6T15AY/CAY | 0.2 | 1 | 12.8 | 14.3 | 15.0 | 15.8 | 1 | 21.2 | 28 | 0.193 | 27.2 | 147 | 0.078 | 8.40 |
| SM6T16V5AY/CAY | 0.2 | 1 | 14.1 | 15.7 | 16.5 | 17.3 | 1 | 23.1 | 26 | 0.254 | 29 | 136 | 0.092 | 8.60 |
| SM6T18AY/CAY | 0.2 | 1 | 15.3 | 17.1 | 18.0 | 18.9 | 1 | 25.2 | 24.0 | 0.263 | 32.5 | 123 | 0.111 | 8.80 |
| SM6T22AY/CAY | 0.2 | 1 | 18.8 | 20.9 | 22.0 | 23.1 | 1 | 30.6 | 20.0 | 0.375 | 39.3 | 102 | 0.159 | 9.20 |
| SM6T24AY/CAY | 0.2 | 1 | 20.5 | 22.8 | 24.0 | 25.2 | 1 | 33.2 | 18.0 | 0.444 | 42.8 | 93.0 | 0.189 | 9.40 |
| SM6T27AY/CAY | 0.2 | 1 | 23.1 | 25.7 | 27.0 | 28.4 | 1 | 37.5 | 16.0 | 0.569 | 48.3 | 83.0 | 0.240 | 9.60 |
| SM6T30AY/CAY | 0.2 | 1 | 25.6 | 28.5 | 30.0 | 31.5 | 1 | 41.5 | 14.5 | 0.69 | 53.5 | 75.0 | 0.293 | 9.70 |
| SM6T33AY/CAY | 0.2 | 1 | 28.2 | 31.4 | 33.0 | 34.7 | 1 | 45.7 | 13.1 | 0.84 | 59.0 | 68.0 | 0.357 | 9.80 |
| SM6T36AY/CAY | 0.2 | 1 | 30.8 | 34.2 | 36.0 | 37.8 | 1 | 49.9 | 12.0 | 1.01 | 64.3 | 62.0 | 0.427 | 9.90 |
| SM6T39AY/CAY | 0.2 | 1 | 33.3 | 37.1 | 39.0 | 41.0 | 1 | 53.9 | 11.1 | 1.16 | 69.7 | 57.0 | 0.504 | 10.0 |
| SM6T42AY/CAY | 0.2 | 1 | 36.0 | 40.0 | 42.1 | 44.2 | 1 | 58.1 | 10.3 | 1.35 | 76.0 | 52.0 | 0.611 | 10.0 |
| SM6T47AY/CAY | 0.2 | 1 | 40.0 | 44.4 | 46.7 | 49.0 | 1 | 64.5 | 9.7 | 1.59 | 84.0 | 48.0 | 0.728 | 10.1 |
| SM6T56AY/CAY | 0.2 | 1 | 47.6 | 53.2 | 56.0 | 58.8 | 1 | 76.6 | 7.8 | 2.28 | 100 | 40.0 | 1.03 | 10.0 |
| SM6T68AY/CAY | 0.2 | 1 | 58.1 | 64.6 | 68.0 | 71.4 | 1 | 92 | 6.5 | 3.17 | 121 | 33.0 | 1.50 | 10.4 |
| SM6T75AY/CAY | 0.2 | 1 | 64.1 | 71.3 | 75.0 | 78.8 | 1 | 103 | 5.8 | 4.17 | 134 | 30.0 | 1.84 | 10.5 |
| SM6T82AY/CAY | 0.2 | 1 | 70.0 | 77.8 | 81.9 | 86.0 | 1 | 113 | 5.5 | 4.91 | 146 | 27.0 | 2.22 | 10.5 |

1. Pulse test: $t_p < 50\text{ ms}$

2. To calculate maximum clamping voltage at another surge level, use the following formula:

$$V_{CLmax} = V_{CL} - R_D \times (I_{PP} - I_{PPappli}) \text{ where } I_{PPappli} \text{ is the surge current in the application.}$$

3. To calculate V_{BR} or V_{CL} versus junction temperature, use the following formulas:

$$V_{BR} @ T_J = V_{BR} @ 25^{\circ}\text{C} \times (1 + \alpha T \times (T_J - 25))$$

$$V_{CL} @ T_J = V_{CL} @ 25^{\circ}\text{C} \times (1 + \alpha T \times (T_J - 25))$$

4. Surge capability given for both directions for unidirectional and bidirectional types.

Figure 3. Peak power dissipation versus initial junction temperature (typical values)

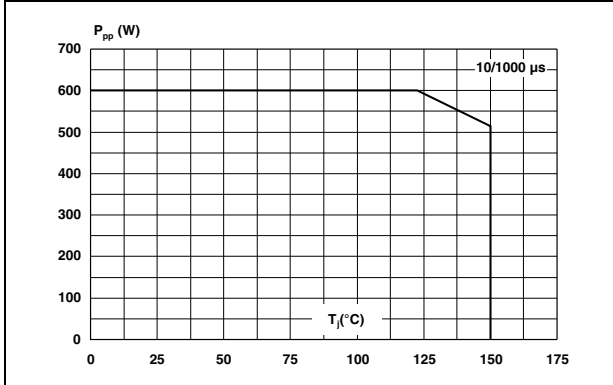


Figure 4. Peak pulse power versus exponential pulse duration

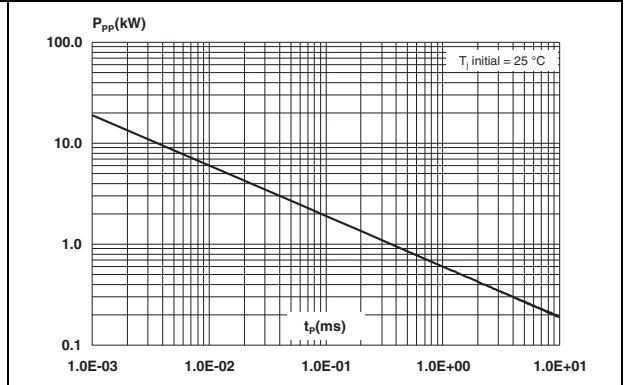


Figure 5. Clamping voltage versus peak pulse current exponential waveform (maximum values)

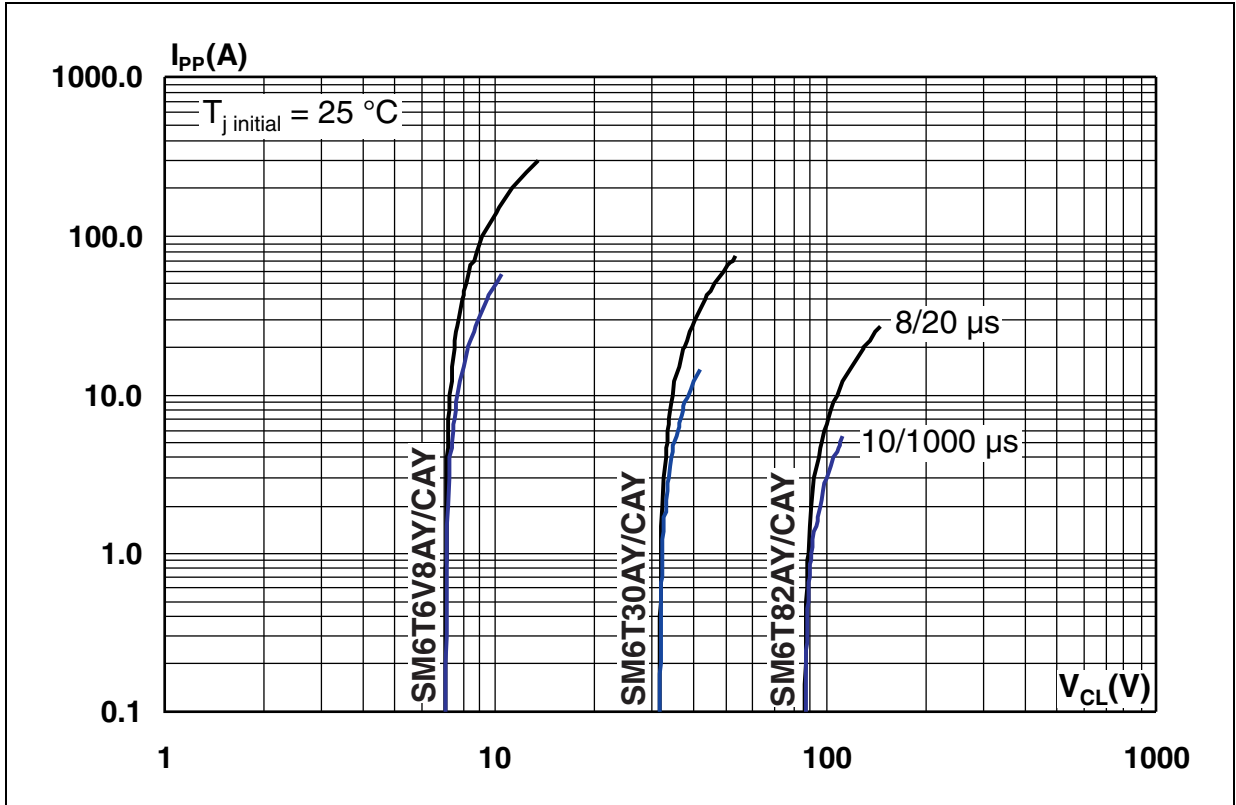


Figure 6. ISO 7637-2 pulse 1 response ($V_S = -150\text{ V}$)

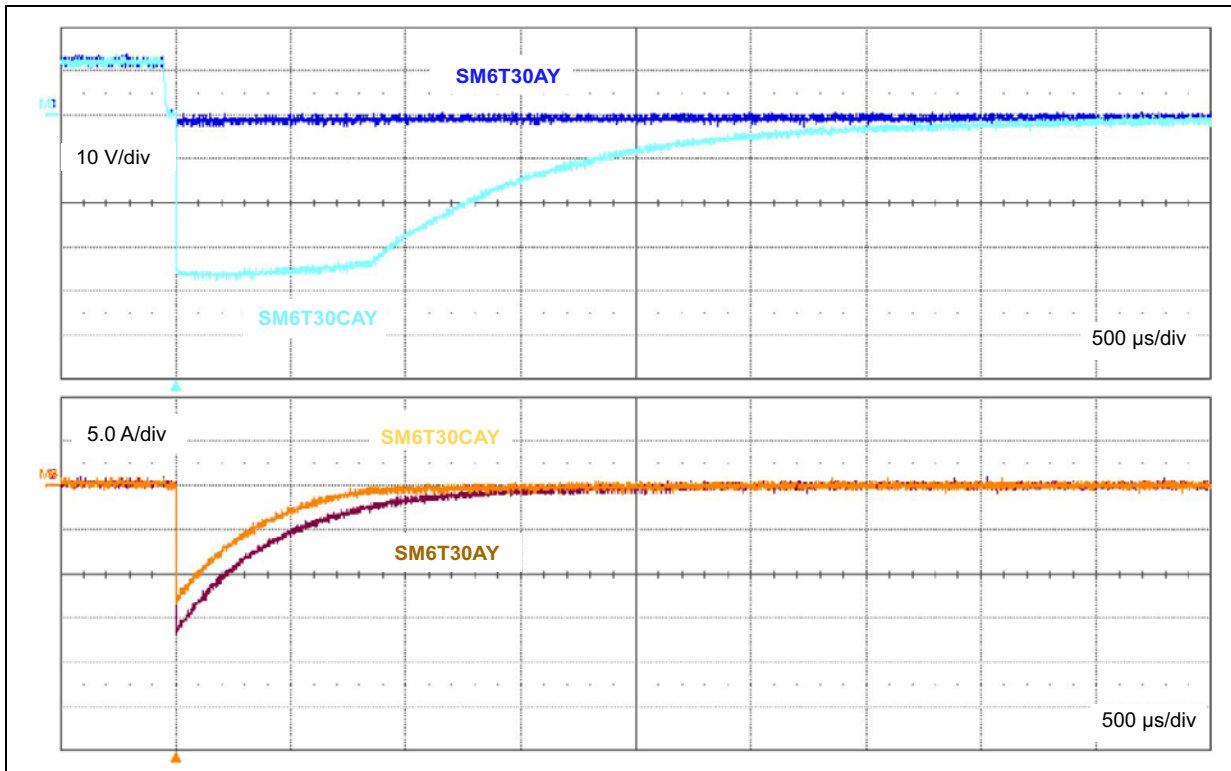


Figure 7. ISO 7637-2 pulse 2a response ($V_S = 112\text{ V}$)

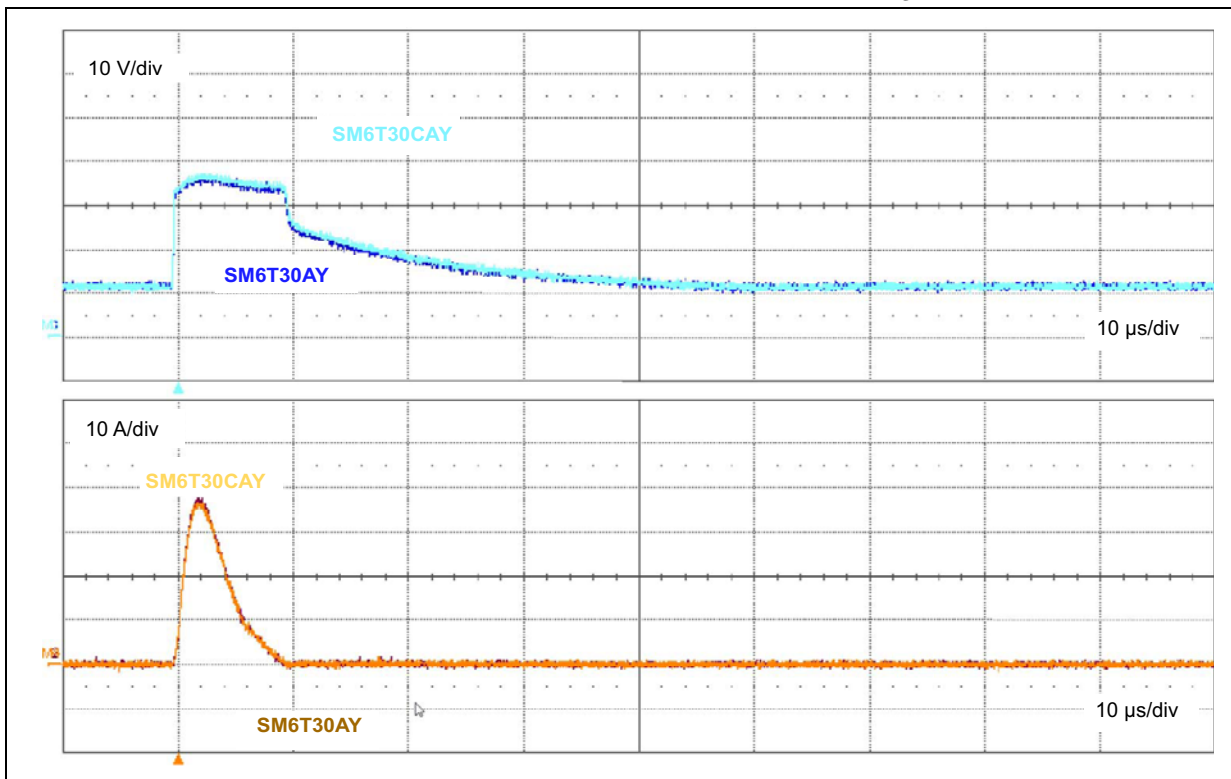


Figure 8. ISO 7637-2 pulse 3a response ($V_S = -220\text{ V}$)

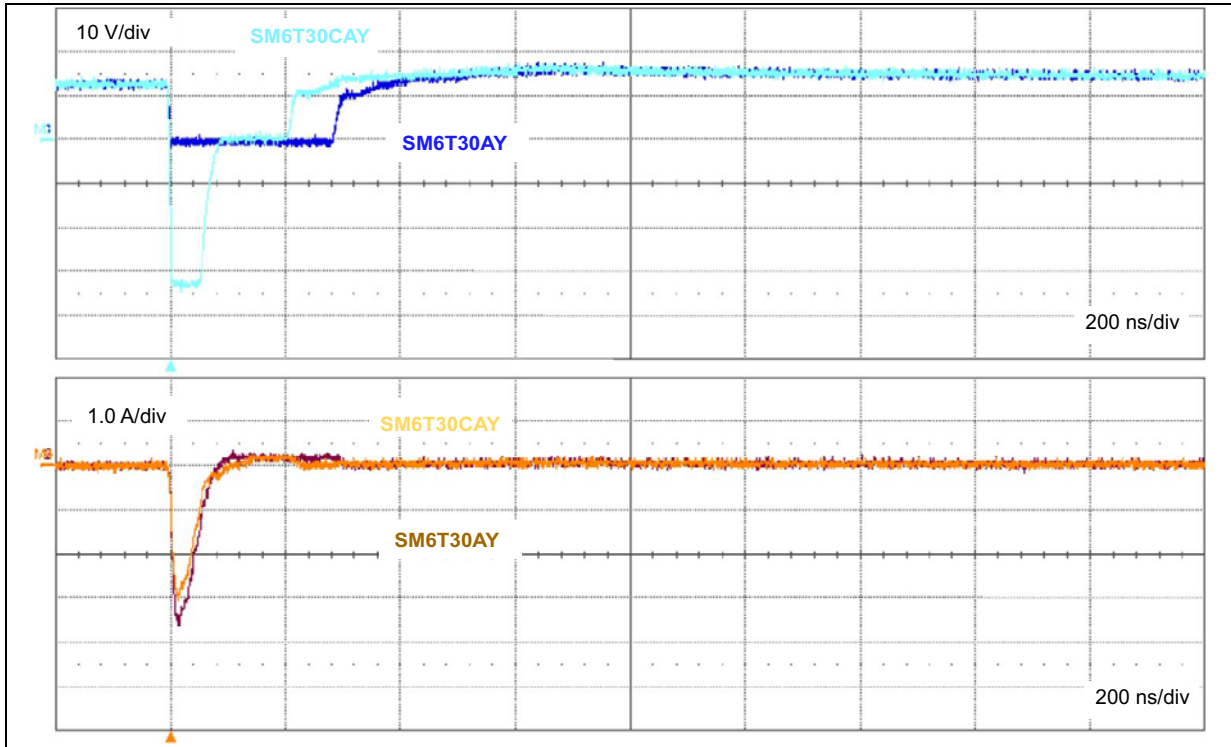
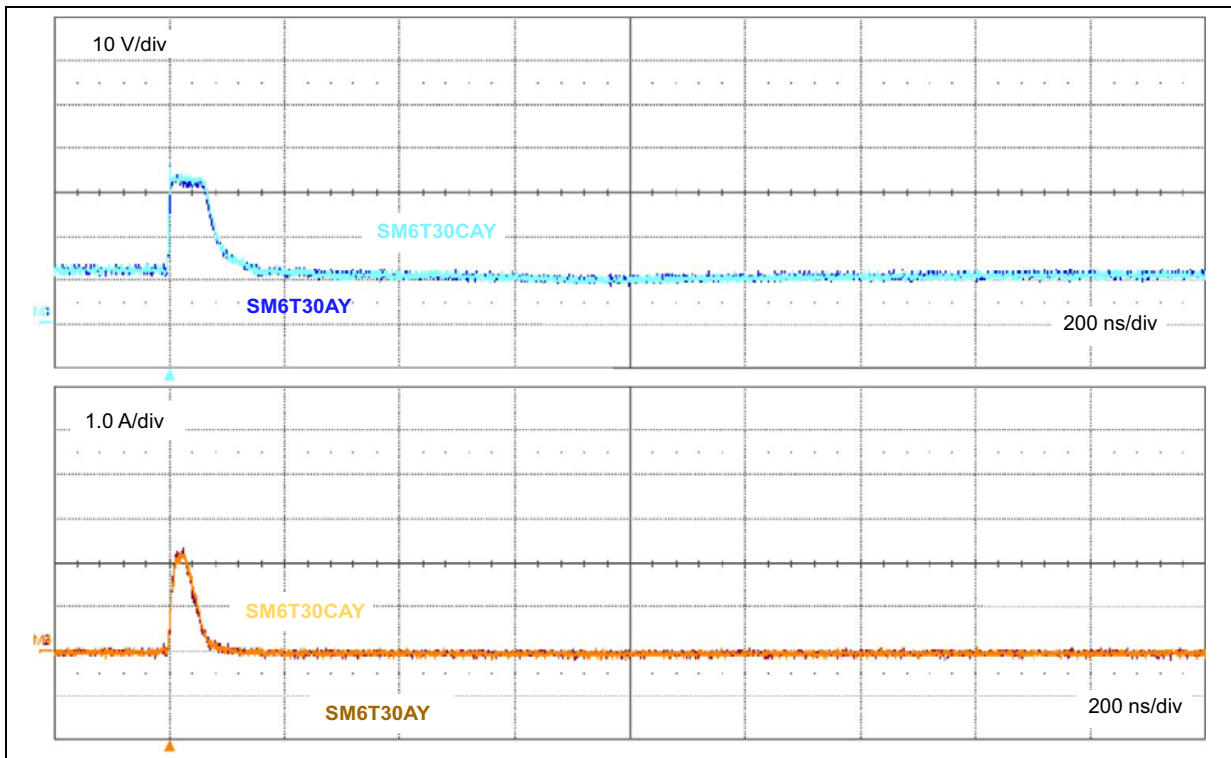


Figure 9. ISO 7637-2 pulse 3b response ($V_S = 150\text{ V}$)



Note: ISO7637-2 pulses responses are not applicable for products with a stand off voltage lower than the average battery voltage (13.5 V).

Figure 10. Junction capacitance versus reverse applied voltage for unidirectional types (typical values)

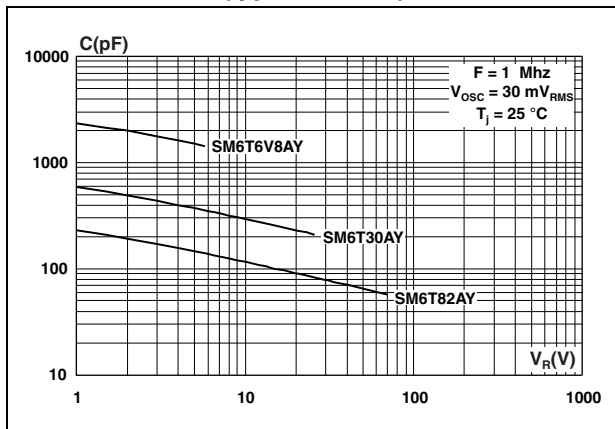


Figure 11. Junction capacitance versus reverse applied voltage for bidirectional types (typical values)

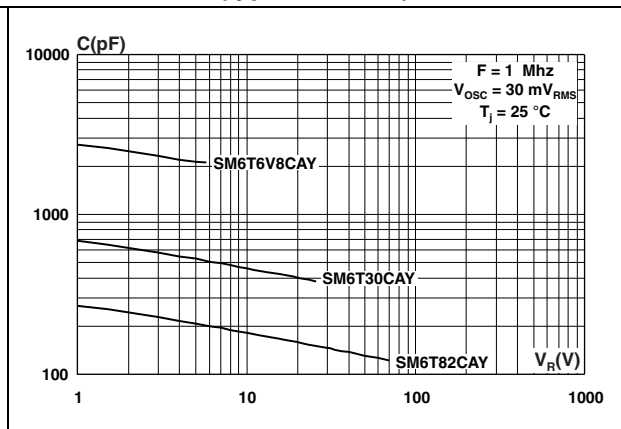


Figure 12. Relative variation of thermal impedance junction to ambient versus pulse duration

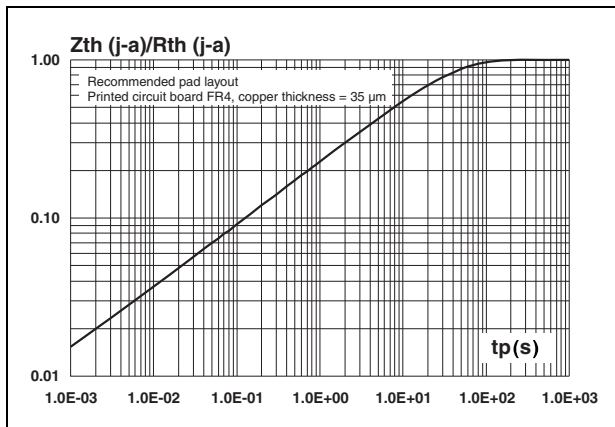


Figure 13. Thermal resistance junction to ambient versus copper surface under each lead

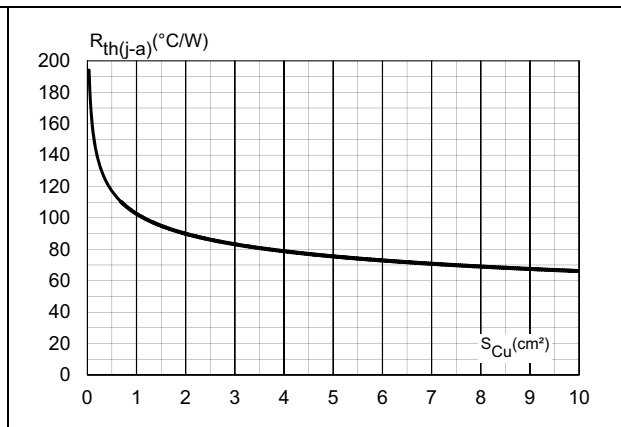


Figure 14. Leakage current versus junction temperature (typical values)

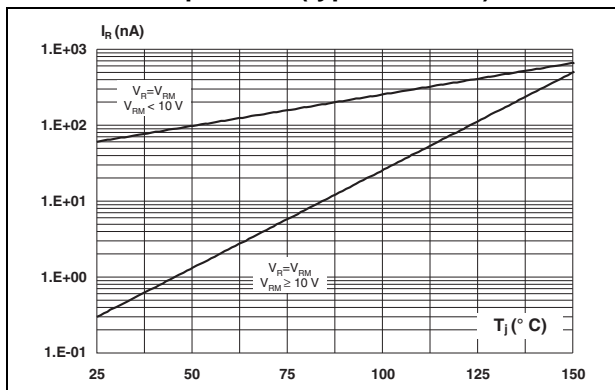
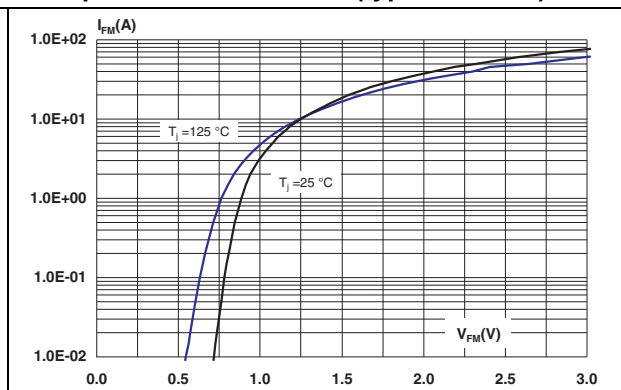


Figure 15. Peak forward voltage drop versus peak forward current (typical values)



2 Application and design guidelines

More information is available in the ST Application note AN2689 "Protection of automotive electronics from electrical hazards, guidelines for design and component selection".

3 Packaging information

- Case: JEDEC DO-214AA molded plastic over planar junction
- Terminals: solder plated, solderable as per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 16. SMB dimensions (definitions)

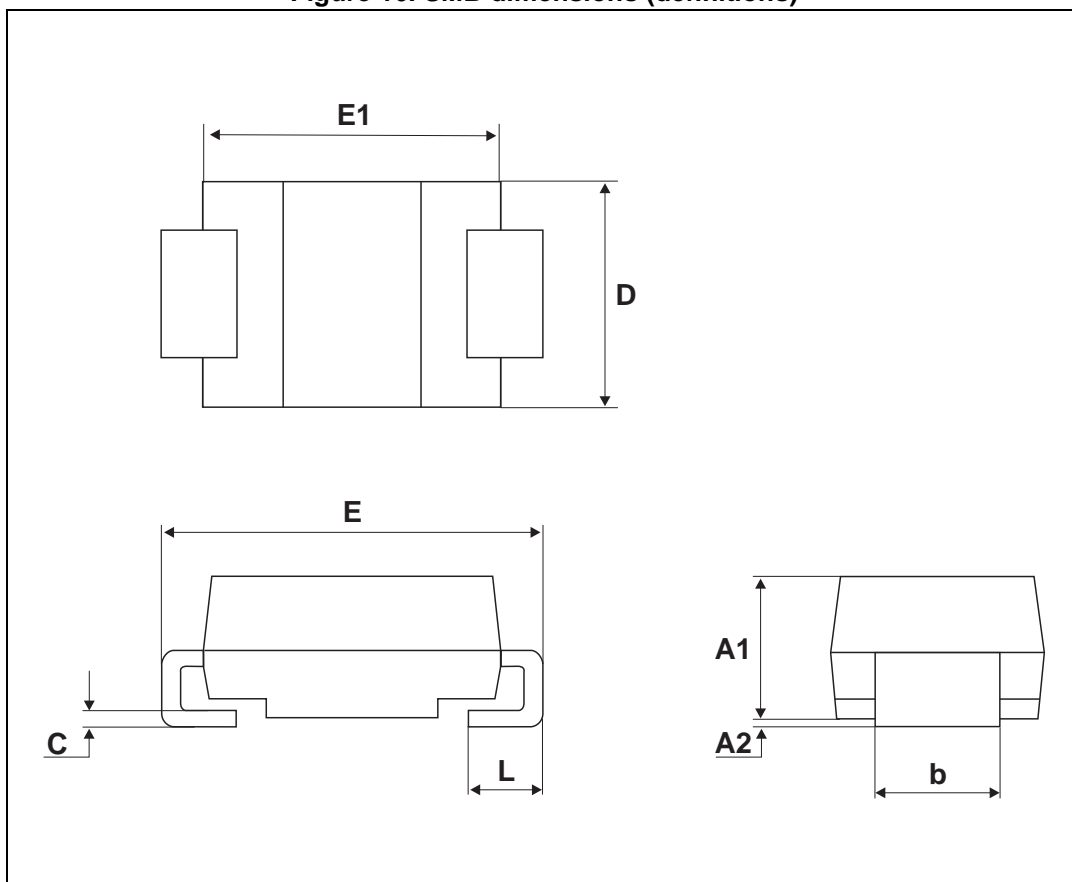


Table 3. SMB dimensions (values)

| Ref. | Dimensions | | | |
|------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.075 | 0.096 |
| A2 | 0.05 | 0.20 | 0.002 | 0.008 |
| b | 1.95 | 2.20 | 0.077 | 0.087 |
| c | 0.15 | 0.40 | 0.006 | 0.016 |
| D | 3.30 | 3.95 | 0.130 | 0.156 |
| E | 5.10 | 5.60 | 0.201 | 0.220 |
| E1 | 4.05 | 4.60 | 0.159 | 0.181 |
| L | 0.75 | 1.50 | 0.030 | 0.059 |

Figure 17. SMB footprint dimensions in mm (inches)

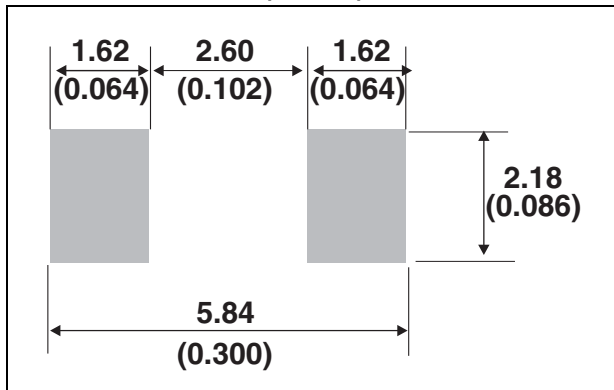
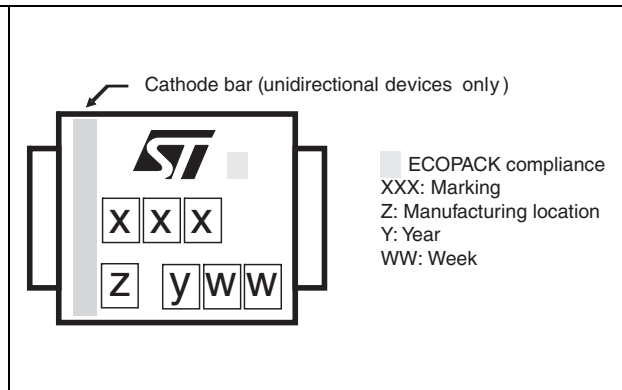


Figure 18. Marking layout⁽¹⁾



1. Marking layout can vary according to assembly location.

Table 4. Marking

| Order code | Marking | Order code | Marking |
|------------|---------|-------------|---------|
| SM6T6V8AY | DEY | SM6T6V8CAY | LEY |
| SM6T7V5AY | DGY | SM6T7V5CAY | LGY |
| SM6T10AY | DPY | SM6T10CAY | LPY |
| SM6T12AY | DTY | SM6T12CAY | LTY |
| SM6T15AY | DXY | SM6T15CAY | LXY |
| SM6T16V5AY | DZY | SM6T16V5CAY | LZY |
| SM6T18AY | EEY | SM6T18CAY | MEY |
| SM6T22AY | EKY | SM6T22CAY | MKY |
| SM6T24AY | EMY | SM6T24CAY | MMY |
| SM6T27AY | EPY | SM6T27CAY | MPY |
| SM6T30AY | ERY | SM6T30CAY | MRY |
| SM6T33AY | ETY | SM6T33CAY | MTY |
| SM6T36AY | EVY | SM6T36CAY | MVY |
| SM6T39AY | EXY | SM6T39CAY | MXY |
| SM6T42AY | FBY | SM6T42CAY | NAY |
| SM6T47AY | FAY | SM6T47CAY | NBY |
| SM6T56AY | FLY | SM6T56CAY | NLY |
| SM6T68AY | FQY | SM6T68CAY | NQY |
| SM6T75AY | FSY | SM6T75CAY | NSY |
| SM6T82AY | FWY | SM6T82CAY | NWY |

4 Ordering information

Figure 19. Ordering information scheme

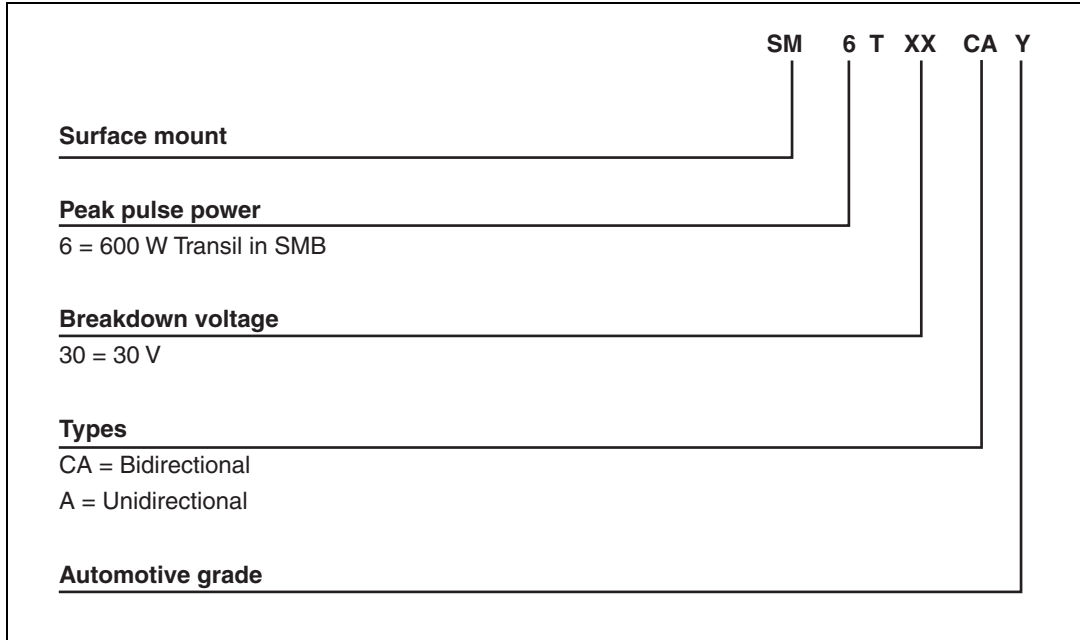


Table 5. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|------------------------------|--|---------|--------|----------|---------------|
| SM6TxxxAy/CAy ⁽¹⁾ | See Table 4 on page 10 | SMB | 0.11 g | 2500 | Tape and reel |

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version. See [Table 2](#) for list of available devices and their order codes

5 Revision history

Table 6. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 15-Sep-2010 | 1 | Initial release. |
| 18-Oct-2011 | 2 | Deleted old Table 2. Thermal parameter. Updated Table 2 and added order codes in Table 4 . Updated Figure 5 , Figure 10 and Figure 11 . Updated Complies with the following standards on page 1 . |
| 27-Mar-2012 | 3 | Added footnote on page 1. |
| 26-Sep-2014 | 4 | Updated Table 2 and Table 4 . Reformatted to current standard. |
| 19-Nov-2014 | 5 | Updated Figure 7 and Figure 8 . |

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